

Annex B2 - Product environmental attributes Servers/Data Storage Products

The declaration may be published only when all rows and/or fields marked with * are filled-in (N/A for not applicable). Additional information regarding each item may be found under P15.

Brand *	Lenovo	Logo			
Company name *	Lenovo				
Contact information *	Lenovo Global Environmental Affairs		Lenovo		
e-mail address	Alvin L Carter				
	alcarter@lenovo.com				
Internet site *	Internet site * https://www.lenovo.com/us/en/about/sustainability				
Additional information	The latest version of this document can be found at:				
	http://www.lenovo.com/ecodeclaration				

The company declares (based on product specification or test results based obtained from sample testing), that the product					
conforms to the stateme	nts given in this declaration.				
Type of product *	Server				
Commercial name *	Lenovo ThinkSystem SR250				
	Lenovo ThinkSystem SR258				
Model number *	7Y51, 7Y52, 7Y72, 7Y53, 7Y73				
Issue date *	Jan 31, 2020				
Intended market * Solobal Europe Asia, Pacific & Japan Americas Other					
Additional information					

This is an uncontrolled copy when in printed form. Please refer to the contact information for the latest version.

About Annex B2

Annex B2 reflects Product environmental attributes relevant for Computers and Computer Monitors. The following items from the ECMA-370 Main body are not shown in the template:

P4.1 – P4.3 Consumable materials

P9.1 TEC and Print speed

P10.2 - P10.3 Chemical emissions from printing products

P11.1 - P11.3 Consumable materials for printing products

Model n	umber *	7Y51, 7Y52, 7Y72, 7Y53, 7Y73	Logo					
Issue da	ate *	Jan 31, 2020		Lend		Отн		
Produc	t environ	mental attributes - Legal requirements		Require	ment	t met		
ltem				Yes	No	N/A		
P1		ous substances and preparations						
P1.1*	Product	do comply with current European RoHS Directive. (See legal reference and NOTE	EB1)	\boxtimes				
P1.2*	Products do not contain Asbestos (see legal reference). Comment: Legal reference has no maximum concentration value.							
P1.3*	hydrobro trichloro	s do not contain Ozone Depleting Substances: Chlorofluorocarbons (CFC), pmofluorocarbons (HBFC), hydrochlorofluorcarbons (HCFC), Halons, carbontetrach ethane, methyl bromide (see legal reference). Comment: Legal reference has no m ration values.						
P1.4*		s do not contain more than; 0,005% polychlorinated biphenyl (PCB), 0,005% polych l (PCT) in preparations (see legal reference).	lorinated	\boxtimes				
P1.5*	Product	do not contain more than 0,1% short chain chloroparaffins (SCCP) with 10-13 cart ntaining at least 48% per mass of chlorine in the SCCP (see legal reference).	oon atoms in	the 🔀				
P1.6*	(see leg	th direct and prolonged skin contact do not release nickel in concentrations above 0 al reference). nt: Max limit in legal reference when tested according to EN1811:2011-5.),5 μg/cm²/we	ek				
P1.7*	REACH	Article 33 information about substances in articles is available at (add URL or mail o ww.lenovo.com/us/en/sustainability-resources	contact):	\boxtimes				
P2	Batterie							
P2.1*	If the product contains a battery or an accumulator, the battery/accumulator is labeled with the disposal symbol. Information on proper disposal is provided in user manual. (See legal reference)							
P2.2*	Batteries or accumulators do not contain more than 0,0005% of mercury or 0,002% of cadmium. (See legal reference)							
P2.3*	Batterie	and accumulators are readily removable. (See legal reference)		\square				
P2.4*	Docume	ntation includes the number of cycles the (secondary) battery can withstand. (See l	egal referenc	e)				
P2.5*	When internal batteries of a notebook computer cannot be "accessed and replaced by a nonprofessional user", the related text is present and legible on the external packaging (see legal reference)							
P3		nity verification & Eco design (ErP)						
P3.1*		duct is CE-marked to show conformance with applicable legal requirements (see leg laration of Conformity can be requested at: https://www.lenovo.com/us/en/complian).				
P3.2*		duct complies with the Eco design requirements for energy-related products, al reference).		\boxtimes				
	Require	d information is; given in item P15 or added to this document, available at: https://www.lenovo.com/us/en/compliance/e	oco-declaratio					
P5	Product	packaging						
P5.1*	Packagi	ng and packaging components do not contain more than 0,01% lead, mercury ent chromium by weight of these together.	y, cadmium	and 🔀				
P5.2*	The packaging materials are marked with abbreviations and numbers indicating the nature of the material(s)							
P5.3*	The pro	used (see legal reference). The product packaging material is free from ozone depleting substances as specified in the Montreal Protocol (see legal reference). Comment: Legal reference has no maximum concentration values.						
P6		nt information						
P6.1*		on for recyclers/treatment facilities is available (see legal reference).						
				<u> </u>				

NOTE B1 Restriction applies to the homogeneous material, unless other specified and expressed in weight %. Stating "Yes" means that the product is compliant with the mandatory requirements.

Model number * Issue date *		7Y51, 7Y52, 7Y72, 7Y53, 7Y73				
		Jan 31, 2020	Len	Lenovo		
Produc	t environ	mental attributes - Market requirements (See General NOTE GN below)				
		onmental conscious design	Require	ement	met	
Item		tory to fill in. Additional information regarding each item may be found under P14.	Yes	No	N/A	
P7.1*	<u> </u>	Disassembly, recycling at have to be treated separately are easily separable				
					<u> </u>	
P7.2*	Plastic materials in covers/housing have no surface coating.					
P7.3*	Plastic parts > 100 g consist of one material or of easily separable materials.					
P7.4*		arts > 25 g have material codes according to ISO 11469 referring ISO 1043-4.		<u> </u>		
P7.5		arts are free from metal inlays or have inlays that can be removed with commonly available tools				
P7.6*		re easily separable. (This requirement does not apply to safety/regulatory labels).				
D7 7*	Product					
P7.7*		ng can be done e.g. with processor, memory, cards or drives		<u> </u>	<u> </u>	
P7.8*		ng can be done using commonly available tools	\square		<u> </u>	
P7.9		arts are available after end of production for: years				
P7.10		s available after end of production for: years				
D7 44 4		and substance requirements				
P7.11*		cover/housing material type (e.g. plastics, metal, aluminum):				
P7.12		type: <i>Plastic</i> Material type: <i>Metal</i> Material type: n materials of external electrical cables are PVC free.		\square		
P7.13		n materials of internal electrical cables are PVC free.			╞	
P7.14		plastic casing/cover parts > 25 g contain no more than $0,1\%$ weight (1000 ppm) bromine and 0),1%			
1 7.14	weight (' polyvinyl	1000 ppm) chlorine attributable to brominated flame retardants, chlorinated flame retardants, ch	and			
P7.15	Printed of as define	ircuit boards, PCBs (without components) are low halogen: all \square PCBs > 25 g \square are low halo ad in IEC 61249-2-21. (See ⁵ NOTE B2)	ogen 🔀			
P7.16	Flame re Marking:	etarded plastic parts > 25 g in covers / housings are marked according ISO 1043-4:				
P7.17		nemical specifications of flame retardants in printed circuit boards > 25 g (without components): additive) , TBBPA (reactive) (See NOTE B3), Other: chemical name: , CAS #:				
		nemical specifications of flame retardants in printed circuit boards (without components) > 25 g g ISO 1043-4:				
P7.18	concentr 1. Chem 2. Chem	ame retarded plastic parts > 25 g contain the following flame retardant substances/preparation ations above 0,1%: ical name: , CAS #: (See NOTE B4) ical name: , CAS #: " ical name: , CAS #: "	is in			
		nemical specifications of flame retardants in plastic parts > 25 g according ISO 1043-4:				
P7.19		parts > 25 g, flame retardant substances/preparations above 0,1% are used which have been				
	0	the following Risk phrases; and Hazard statements:				
P7.20*		rce(s) for these classifications is/are found at (add URL(s)): , (See note B5) sumer recycled plastic material content is used in the product (See Note B6):		\square		
	a) Oft ape or	at least one of the two alternatives below shall be answered; total plastic parts' weight > 25 g, the postconsumer recycled plastic material content (calculated ercentage of total plastic by weight) is %.	as			

GENERAL NOTE Standard references should direct to the latest version of a standard. If an older version of a standard is used, section P15 shall be used for explanation.

NOTE B2 IEC 61249-2-21 defines maximum limits of 900 ppm for each of the substances chlorine and bromine and a maximum limit of 1500ppm of these substances combined. The standard does not address fluorine, iodine and astatine which are included in the group of halogens.

NOTE B3 and B4 A Guidance document on Chemical substances is available; see <u>http://www.ecma-international.org/publications/standards/Ecma-370.htm</u>.

NOTE B5 If a certain substance has been assigned a certain risk phrases / hazard statement in the referenced source, this does not necessarily mean the substance has been tested for all of the hazards referred to by a certain customer.

NOTE B6 Applies to a product containing plastic parts whose combined weight exceeds 100 g with the exception of printed circuit boards, cables, connectors and electronic components and bio-based plastic material.

Model number *	7Y51, 7Y52, 7Y72, 7Y53, 7Y73	Logo	Lenovo		
Issue date *	Jan 31, 2020				
Product environmental attributes - Market requirements (continued) Requirement met					

Requirement metYesNoN/A

	Material and su	bstance requirements	(continued)				
P7.21*		material content is used		DTE B7):			
	If YES: at least o	one of the two alternative	s below shall be answe	ered.			
		stic parts' weight > 25 g,			ted as a percentage of		
	total plastic	by weight) is %.					
	or b) The weight	of the highered plactic r	notorial in a				
P7.22*		of the biobased plastic n e free from mercury, i.e.					
1 1.22		d specify: Number of lan		um mercury content pe	er lamp: mg		
P7.23*		es an integral display, the					
P8	Batteries						
P8.1*	Battery chemica	l composition: Lithium N	langanese Dioxide				
P9		ption (See NOTE B8)					
P9.1		he following power level					
Energy mo	ode *	Power level at	Power level at	Power level at	Reference/Standard for energy modes and test method *		
100% stre	cc	100 V AC 266.48 W	115 V AC 268.83 W	230 V AC 263.20 W	100% stress		
Off state	33	9.39 W	9.33 W	9.02 W	10 mins after AC cord in		
Idle state		106.09 W	104.76 W	103.46 W	10 mins after logging in OS		
Peak (On-	max)	W	W	W	Full load		
Categor	N						
EPS No-loa		W	W	W			
	ower supply /	vv	vv	vv			
charger plu	ugged in the wall						
	disconnected from						
the product	t.)	W	W	W			
= •	ergy Consumptior		vv	vv			
ETEC *		kWh/year	kWh/year	kWh/year			
	ergy Consumption		-	-			
		ency Level (International	Efficiency Marking Pro	tocol) * :			
Display res	solution * :	megapixels			\square		
Default tim	e to enter energy						
P9.2*	Information about	ut the energy save function	on is provided with the	product.			
P9.3	Energy efficienc	y class (monitors only):					
P10	Emissions						
B 40.4		 Declared according to 	ISO 9296 (See NOTE				
P10.1	Mode Idle	Mode description * max configuration		Statistical upper limit A-weighted sound power level, $L_{WA,c}$ (B)			
		-		* 5.12			
	Operation	* max configuration Declared A-weighted sound	d processo (cuc) (dP)				
	Other mode	L_{pAm}	u pressure ievei (ub)	(operator pos	sition desktop – idle)		
	Other mode	Declared A-weighted sound	d pressure level (dR)	(operator ne	sition desktop – operating)		
	L_{pAm}				σπου ασοπορ – ομειαπιμ		
	Measured according to: X ISO 7779 ECMA-74						
1	Other (only if not covered by ECMA-74) Electromagnetic emissions						
P10.4	Computer display meets the requirement for low frequency electromagnetic fields of the following voluntary						
	program(s):						

Item

NOTE B7 The following is to be excluded from the calculation of percentage: printed circuit boards, labels, cables, connectors and electronic components and postconsumer recycled plastic

NOTE B8 A Guidance document on Energy Efficiency is available; see http://www.ecma-international.org/publications/standards/Ecma-370.htm

NOTE B9 A Guidance document on Acoustic Noise is available; see http://www.ecma-international.org/publications/standards/Ecma-370.htm

Model nu	mber *	7Y51, 7Y52, 7Y	72, 7Y53, 7Y73		Logo	Long		
Issue date *		Jan 31, 2020				Leno	VO	тн
Product	environn	nental attribut	es - Market requiremen	ts (continued)		Require	ment	met
Item						Yes	No	N/A
P12	Ergonor	nics for compu	ing products					
P12.1*	The disp	lay meets the er	gonomic requirements of ISC	O 9241-307 for visual	display technologies.	\square		
P12.2*	The phys	sical input device	meets the requirements of	ISO 9995 and ISO 924	41-410.	\square		
P13	Packaging and documentation							
P13.1*	Product	packaging mater	ial type(s): Corrugated ca ial type(s): Recycled Expa ial type(s): PP weight (kg):	nded Polyethylene	ght (kg): 2.1 weight (kg): 0.52			
P13.2*			ackaging is free from PVC.			\square		
P13.3*		uct primary cor		ng, specify the contai	ned percentage of minimum			
P13.4*		nedia for user ar onic, XPaper,	d product documentation (ti	ck box):				
P13.5	5 (Please only complete this item if paper documentation used) User and product documentation on paper media is chlorine-free:							
		hlorine-free al chlorine-free						
	Processe	ed chlorine-free				Ħ		
P14	Volunta	ry programs						
P14.1			quirements of the following	voluntary program(s):				
	ENERG` Eco-labe Eco-labe		Criteria version: Criteria version: Criteria version:	Date: Date: Date:	Product category: Product category: Product category:			
P15	Addition	al information	See NOTE B10)					
P9			computer products; desc					
	the info supplier informa	rmation contain 's knowledge a tion. The inform	ed in this document. All in vailable at the time of com	formation provided pletion, and supplied	r warranties whether expres by supplier in this docume r shall have no obligation to led for informational purpo	nt is provided in o update such	based	d on
P9			ed Enterprise Servers for a gov/products/data_center					

NOTE B10 Additional lines may be inserted to declare further items, by positioning the cursor at the far right of the row and hitting the <Enter> key.

Legal references Europe Annex B2

Reference	Declaration item
Directive 2011/65/EU (RoHS Directive)* * Specific exemptions apply for certain products and applications.	P1.1, P3.1
Regulation (EC) 1907/2006 (REACH Regulation), annex XVII	P1.2, P1.4, P1.6, P1.7
Regulation (EC) 2037/2000, 2038/2000, 2039/2000 (Marketing and use of Ozone layer depleting substances)	P1.3, P5.3
Norwegian regulation relating to restrictions on the use of certain dangerous chemicals 20.12.2002	P1.5
Directive 2006/66/EC (Battery and accumulators Directive), as amended.* * These provisions shall not apply where, for safety, performance, medical or data integrity reasons, continuity of power supply is necessary and requires a permanent connection between the appliance and the battery or accumulator.	P2.1, P2.2, P2,3, P8.1
Directive 2014/35/EU (Low Voltage Directive)	P3.1
Directive 2014/30/EU (EMC Directive)	P3.1
Directive 2014/53/EU (RE Directive)	P3.1
Regulation (EC) 801/2013 amending Regulation (EC) No 1275/2008 with regard to ecodesign requirements for standby, off mode electric power consumption of electrical and electronic household and office equipment, and amending Regulation (EC) No 642/2009 with regard to ecodesign requirements for televisions	P3.1, P3.2
Commission Regulation (EC) No 278/2009 of 6 April 2009 implementing Directive 2005/32/EC of the European Parliament and of the Council with regard to ecodesign requirements for no-load condition electric power demand and average active efficiency of external power supplies	P3.1, P3.2, P9.1
COMMISSION REGULATION (EU) No 617/2013 of 26 June 2013 implementing Directive 2009/125/EC of the European Parliament and of the Council with regard to ecodesign requirements for computers and computer servers	P2.4, P2.5, P3.1, P3.2, P7.23, P9.1
Regulation (EC) No 1272/2008 (CLP Regulation)	P7.19
Directive 2004/12/EC (Packaging Directive)	P5.1
Decision 97/129/EC (Secondary packaging legislation)	P5.2
Directive 2012/19/EU (WEEE directive)	P6.1
Implementing Regulation (EU) 2019/290 establishing the format for registration and reporting of producers of electrical and electronic equipment to the register.	
Commission Implementing Regulation 2017/699 establishing a common methodology for the calculation of the weight of electrical and electronic equipment (EEE) placed on the national market in each Member State and a common methodology for the calculation of the quantity of waste electrical and electronic equipment (WEEE) generated by weight in each Member State.	

Lenovo ErP Lot9 Information Sheet - Servers & Storage Products-

As required by COMMISSION REGULATION (EU) 2019/424 of 15 March 2019 laying down ecodesign requirements for servers and data storage products pursuant to Directive 2009/125/EC of the European Parliament and of the Council and amending Commission Regulation (EU) No 617/2013. (ErP Lot9)

Products scope of this sheet: Servers & storage products

This document is only valid in connection with the IT Eco Declaration of the specific Product.

SERVERS

 General information

 Commercial name (3.1 (b))
 Lenovo ThinkSystem SR250
 Logo

 Contact Address (3.1 (b))
 7001 Development Dr. Building 7,Morrisville, NC 27560, United
 Logo

 Model Number (3.1 (c))
 7Y51, 7Y52, 7Y72, 7Y53, 7Y73
 Lenovo

 Issue Date
 Jan 31, 2020
 Lenovo

Product env	vironmental attributes (EU) 2019/424 – Annex II points 3.1 and 3.3					
	s the product consider to be in scope of ErP Lot 9 🛛 🔀 in scope 🗌 out of scope, product is out of scope as:					
1.b S (3.1 (a))	Server type Rack Server High Performance Computing (HPC) Tower Server Multi Node Server Blade Server Data Storage product (Please go to "DATA STORAGE PRODUCTS" section					
	Year of manufacture: 2019					
^{(3.1 (p))} L	Product model part of a server product family? No X Yes List of all model configurations that are represented by the model: <u>http://psref.lenovo.com/Product/ThinkSystem/ThinkSystem_SR250</u>					
	http://psref.lenovo.com/Product/ThinkSystem/ThinkSystem_SR250 Information on the secure data deletion functionality (a) instructions on how to use the functionality: 2 methods are provided to use the functionality. 1) Use a command line tool to do the secure data deletion on the remote target system via boot up a customized Linux OS on it. Eg: OneCli.exe serase -bmc USERID:PASSWORD@xx.xx.xx.xxsftp root:password@xx.xxx.xx.x/home -log 5 2) Use BoMC to create a full functions bootable media, start the media and choose secure erase from the text menu. (b) techniques used:					
H N Si	OR - Reference to other information: Hdparm: https://en.wikipedia.org/wiki/Hdparm Nvme-format: https://www.mankier.com/1/nvme-format sg_sanitize: https://www.systutorials.com/docs/linux/man/8-sg_sanitize/ scrub: https://www.systutorials.com/docs/linux/man/1-scrub/ storcli: https://docs.broadcom.com/docs-and-downloads/raid-controllers/raid-controllers-common-iles/StorCLI					
^{(3.1 (o))} lis	Blade servers? X No Yes st of recommended combinations with compatible chassis:					
Recycling D						
	Indicative weight range at component level, of the pollowing critical raw materials: (a) Cobalt in the batteries (b) Neodymium in the HDDs Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g Image: Strain S g					
(3.3 (b))	 nstructions on the disassembly operations (a) the type of operation; (b) the type and number of fastening technique(s) to be unlocked; (c) the tool(s) required. OR - Reference to other information: https://thinksystem.lenovofiles.com/help/index.jsp 					
2.c F R	immware Reference to information on last available firmware: https://datacentersupport.lenovo.com/cn/en/products/servers/thinksystem/sr250/downloads/driver-list/					
Additional in	formation					

Server family specific information Family 1

Family I	no. / name	1 - 1 CPU populated family				
Model n	umber(s) / Description	Standard or low-end performance configuration:				
(3.1 (c))	······	Processor: G4900T(2.9GHz, 2 core), Memory: 16GB, Storage: 1TB HDD *2, PSU: 450W, NIC: n/a				
				•		
		High-end performance config				
		Processor: E2186G(3.8GHz,	6 core), Memory: 64GB, Stora	ge: 960GB SSD *2, PSU: 450W*2, NIC: n/a		
		Please refer to <u>https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=49&type=1</u> along with http://psref.lenovo.com/Product/ThinkSystem/ThinkSystem SR530 for the PSU efficiency				
			.com/Product/ThinkSystem/T	hinkSystem_SR530 for the PSU efficiency		
		details. 300W PSU (DPS-300AB) is compliant with the PSU efficiency and power factor under 230V input voltage.				
	nal information			y and power factor under 230V input voltage.		
Addition		10% load: efficiency 80%, power factor n/a				
		20% load: efficiency 88.5%,	power factor 0.8			
		50% load: efficiency 92.5%,				
		100% load: efficiency 88.5%				
Produc		butes (EU) 2019/424 – Annex I				
F1.a	PSU efficiency at 10	% (if applicable), 20 %, 50 % an	nd 100 % of rated output power			
(3.1 (e))	(expressed in % and	rounded to the first decimal place	ce): 🗌 Multi-output 🛛 🛛 Singl	e-output		
		•	, <u> </u>			
		performance configuration(s):				
	10% 88.24 20% 92	2.57 50% 94.68 100% 94.02	Average 93.76			
	High-end performance		Average 02.76			
F1.b		2.57 50% 94.68 100% 94.02 of the rated load level		nce high-end performance		
(3.1 (f))	(rounded to three de		standard or low-end performation: 0.990	configuration: 0.990		
F1.c	PSU rated power out	, ,	standard or low-end performation			
(3.1 (g))	(in Watts rounded to		configuration: 450 W	configuration: 450 W		
((0))		and field est integer)				
	internal note: If a product model is part of a ser	ver product family, all PSUs offered in a server with the information specified in (e) and (f)				
F1.d	product family shall be reported v idle state power	vith the information specified in (e) and (f)	standard or low-end performa	nce high-end performance		
(3.1 (h))		d to the first decimal place)	the first decimal place) configuration: 34.0 W configuration: 39.1 W			
F1.e		ts for additional idle power allow	·			
(3.1 (i))	List of all component		ances			
		standard or	r low-end performance	high-end performance		
		configuration	on:	configuration:		
	CPU Performance	🔀 1 Sock	et (10 × PerfCPU W)	🔀 1 Socket		
		2 Sock	et (7 × PerfCPU W)	2 Socket		
lowances adjustments rring testing	Additional PSU	No (Yes / No)) #:	Yes (Yes / No) #: 1		
tme	HDD	Yes (Yes / No	o) #: 2	No (Yes / No) #:		
just	SDD	No (Yes / No)		Yes (Yes / No) #: 2		
s ad	Additional memory	Yes (Yes / No		Yes (Yes / No) #: 60GB		
esti	Additional buffered DDF	R channel No (Yes / No))#:	No (Yes / No) #:		
van ng t	Additional I/O devices	none		none		
urir		< 1 Gb/s:	No Allowance	< 1 Gb/s: No Allowance		
idle power allc dur		= 1 Gb/s:	2,0 W/Active Port	= 1 Gb/s: 2,0 W/Active Port		
NO			and < 10 Gb/s: 4,0 W/Active Port	> 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port		
e			and < 25Gb/s: 15,0 W/Active Port	\geq 10 Gb/s and < 25Gb/s: 15,0 W/Active Port		
<u>6</u>				\geq 25 Gb/s and < 50 Gb/s; 20.0 W/Active Port		
			and < 50Gb/s: 20,0 W/Active Port			
	≥ 50 Gb/s 26,0 W/Active Port ≥ 50 Gb/s 26,0 W/Active Port					
F1.f						
(3.1 (j)) F1.g		atts and rounded to the first decimal place)configuration: 48.9 W configuration: 190.8 W ting condition classstandard or low-end performancehigh-end performance				
F1.goperating condition classstandard or low-(3.1 (k))(as defined in Table 6 or ErP lot 9)configuration:				nce high-end performance configuration:		
(0.1 (1.))						
			Exception comments	Exception comments		
F1.h	idle state nower at th	e higher boundary temperature	standard or low-end performation	nce high-end performance		
(3.1 (l)) of the declared operating condition class (in Wa			configuration: 43.0 W	configuration: 41.6 W		
F1.i		ency and the performance in	standard or low-end performan			
(3.1 (m))	active state of the se		configuration: 9.9	configuration: 23.7		